MJE13005

NPN SILICON TRANSISTOR

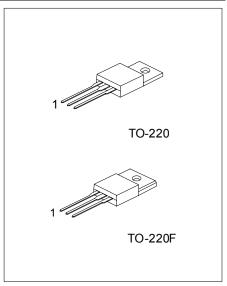
NPN SILICON POWER TRANSISTORS

DESCRIPTION

These devices are designed for high-voltage, high-speed power switching inductive circuits where fall time is critical. They are particularly suited for 115 and 220 V SWITCHMODE.

■ FEATURES

- * V_{CEO(SUS)}= 400 V
- * Reverse bias SOA with inductive loads @ T_C = 100
- * Inductive switching matrix 2 to 4 Amp, 25 and 100 ... tc @ 3A, 100 is 180 ns (Typ)
- * 700V blocking capability
- * SOA and switching applications information



*Pb-free plating product number: MJE13005L

■ APPLICATIONS

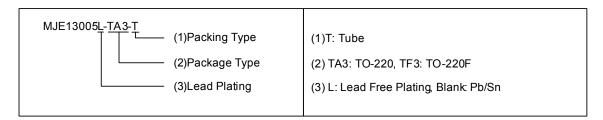
- * Switching regulator's, inverters
- * Motor controls

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- * Solenoid/Relay drivers
- * Deflection circuits

ORDERING INFORMATION

Order Number		Dockago	Pin A	ssignn	Dooking		
Normal	Lead Free Plating	Package	1	2	3	Packing	
MJE13005-TA3-T	MJE13005L-TA3-T	TO-220	В	С	Е	Tube	
MJE13005-TF3-T	MJE13005L-TF3-T	TO-220F	В	С	Е	Tube	



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ABSOLUTE MAXIMUM RATINGS

PARAMETER		SYMBOL	RATINGS	UNIT
Collector-Emitter Voltage		V _{CEO(SUS)}	400	V
Collector-Emitter Voltage		V_{CBO}	700	٧
Emitter Base Voltage		V _{EBO}	9	V
Collector Current	Continuous	Ic	4	Α
	Peak (1)	I _{CM}	8	Α
Base Current	Continuous	Ι _Β	2	Α
	Peak (1)	I _{BM}	4	Α
Emitter Current	Continuous	Ι _Ε	6	Α
	Peak (1)	I _{EM}	12	А
Total Power Dissipation at Ta=25 Derate above 25		Б	2	W
		P _D	16	mW/
Total Power Dissipation at T _C =25 Derate above 25		Б	75	W
		P _D	600	mW/
Operating and Storage Junction Temperature Range		T _J , T _{STG}	-65 ~ +150	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER	SYMBOL	MAX	UNIT
Thermal Resistance, Junction to Ambient	θ_{JA}	62.5	/W
Thermal Resistance, Junction to Case	θ_{JC}	1.67	/W

⁽¹⁾ Pulse Test : Pulse Width=5ms, Duty Cycle≤10%

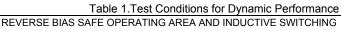
■ ELECTRICAL CHARACTERISTICS (Tc=25 , unless otherwise specified)

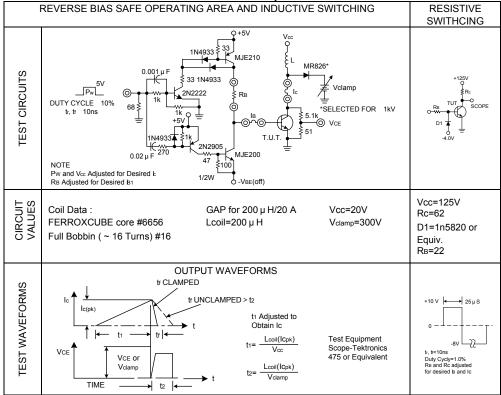
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
*OFF CHARACTERISTICS (1)							
Collector-Emitter Sustaining Voltage	V _{CEO(SUS)}	Ic=10mA , I _B =0	400			V	
Collector Cutoff Current		V _{CBO} =Rated Value, V _{BE(OFF)} =1.5 V			1		
	I _{CBO}	V _{CBO} =Rated Value, V _{BE(OFF)} =1.5V,				mA	
		Tc=100			5		
Emitter Cutoff Current	I _{EBO}	V _{EB} =9V, Ic=0			1	mA	
SECOND BREAKDOWN							
Second Breakdown Collector Current	ls/b			See Figure 11		11	
with bass forward biased	13/10			360	o i igui e	, 11	
Clamped Inductive SOA with Base	RBSOA			Sad	Figure	12	
Reverse Biased	NDSOA		See Figure 1				
*ON CHARACTERISTICS (1)							
DC Current Gain	h _{FE1}	Ic=1A, V _{CE} =5V	10		60		
DC Current Gain	h _{FE2}	Ic=2A, V _{CE} =5V	8		40		
		Ic=1A, I _B =0.2A			0.5	V	
	.,	Ic=2A, I _B =0.5A			0.6	V	
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	AT) Ic=4A, I _B =1A		1	V		
		Ic=2A, I _B =0.5A, Ta=100			1	V	
Base-Emitter Saturation Voltage		Ic=1A, I _B =0.2A			1.2	V	
	V _{BE (SAT)}	Ic=2A, I _B =0.5A			1.6	V	
		Ic=2A, I _B =0.5A, Tc=100			1.5	V	
DYNAMIC CHARACTERISTICS							
Current-Gain-Bandwidth Product	f _T	Ic=500mA, V _{CE} =10V, f=1MHz	4			MHz	
Output Capacitance	Cob	V _{CB} =10V, I _E =0, f=0.1MHz		65		pF	

ELECTRICAL CHARACTERISTICS (Cont.)

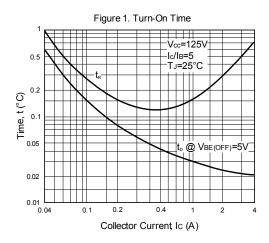
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
SWITCHING CHARACTERISTICS							
Resistive Load (Table 1)							
Delay Time	t_D	Vcc=125V, lc=2A, l _{B1} =l _{B2} =0.4A,		0.025	0.1	μs	
Rise Time	t _R			0.3	0.7	μs	
Storage Time	ts	t _P =25µs, Duty Cycle≤1%		1.7	4	μs	
Fall Time	t _F			0.4	0.9	μs	

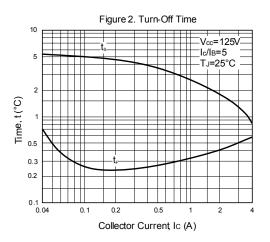
^{*} Pulse Test: Pulse Width=300µs, Duty Cycle≤2%





■ RESISTIVE SWITCHING PERFORMANCE





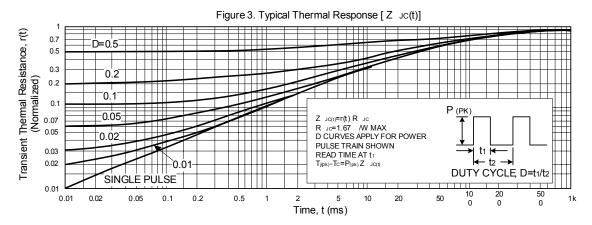
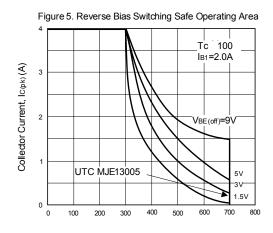


Figure 4. Forward Bias Safe Operating Area

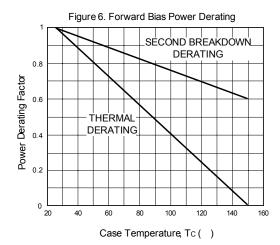
10
5
6
2
2
0.5
0.02
0.02
0.02
0.01
5
7
10
20
30
50
70
100
200
300
400

Collector-Emitter Voltage, VcE (V)



Collector-Emitter Clamp Voltage, VcE (V)

■ RESISTIVE SWITCHING PERFORMANCE



■ SAFE OPERATING AREA INFORMATION

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_{C^{-}}V_{CE}$ limits of the transistor that must be observed for reliable operation; e., the transistor must not be subjected to greater dissipation than the curves indicate.

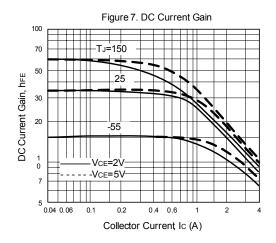
The data of Figure 4 is based on T_C = 25 ; $T_J(pk)$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when $T_C \ge 25$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 4 may be found at any case temperature by using the appropriate curve on Figure 6.

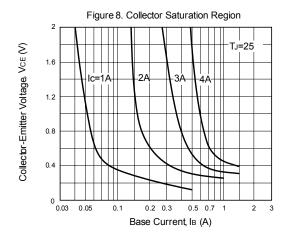
T_J(pk) may be calculated from the data in Figure 10. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

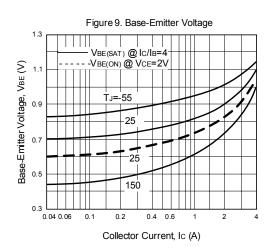
REVERSE BIAS

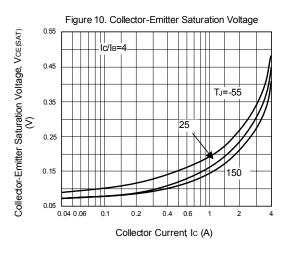
For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 5 gives the complete RBSOA characteristics.

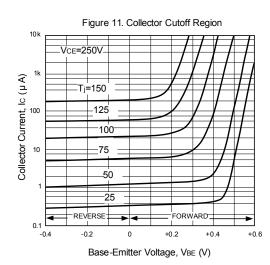
■ TYPICAL CHARACTERISTICS

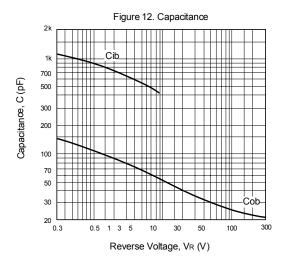












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